

Cite this: *RSC Adv.*, 2017, 7, 56038

Dielectric and current–voltage characteristics of flexible Ag/BaTiO₃ nanocomposite films processed at near room temperature†

Seung Won Kim,[‡] Hong Rak Choi,[‡] Chan Su Han,[‡] Da Bin Kim, Ji Won Kim and Yong Soo Cho^{ID*}

High dielectric constant ceramic–polymer composite materials have been produced by thermal-treatment in the range of 160 to 200 °C. Here, we introduce a room temperature process of generating flexible high dielectric constant nanocomposite films on a polymer substrate by combining a printing technique with a UV-curing process. The composite structure is based on nanoscale BaTiO₃ and Ag particles dispersed in a UV-cured polymer matrix. Dielectric characteristics of the nanocomposite thick films depended on the volume fraction and particle size of BaTiO₃ as well as the content of Ag. As an optimal result, a dielectric constant of ~300 and a dielectric loss of 0.08 were achieved when ~81 nm BaTiO₃ and ~34 nm Ag particles were used in a total volume fraction of 56.2%, which are very competitive for flexible capacitive devices. Current–voltage behavior of the nanocomposite films depended largely on the content of Ag content as related to the percolative transition of electrical conduction.

Received 21st October 2017
Accepted 5th December 2017

DOI: 10.1039/c7ra11640c

rsc.li/rsc-advances

1. Introduction

One of the important issues in flexible electronic packages is to adopt high dielectric constant ϵ_r materials suitable for various potential applications including communication, military and medical uses.^{1–3} The integration of the passive component into the flexible circuit board system requires very low-temperature processing and proper compatibility with a polymer substrate acting as a support for the electronic circuits. Generally, typical high ϵ_r materials, such as ferroelectric ceramics, are broadly used for electronic packaging components because of their promising dielectric properties.^{4–6} However, the ceramics produced by the common processing are brittle and require high-temperature treatment that is not suitable for flexible polymer substrates. The flexible substrates have often advantages over hard substrates in terms of shock resistance, solvent resistance, flexibility, low-cost metallization, *etc.*^{7,8} Many studies have been reported on high ϵ_r ceramic–polymer composites containing different ceramic fillers. Among high ϵ_r ceramic candidates, BaTiO₃ and its modified compositions have been utilized more preferably for the high ϵ_r composites. Various polymers, such as epoxy resin, polyaniline, polyimide, cyclic olefin copolymer (COC), poly(vinylidene fluoride) (PVDF) or poly(vinylidene fluoridetrifluoroethylene) [P(VDF-TrFE)], have

been reported to form a matrix phase effectively for dispersed BaTiO₃ particles through a thermal-curing process in the typical temperature range of 160 to 200 °C.^{8–14} However, there are very limited reports dealing with the printing technology of the composite films, which simultaneously pursues the flexible system, requiring a very low temperature below 100 °C.

This work introduces a composite-type thick film system based on a UV (ultra-violet)-curable polymer matrix incorporating dispersed Ag and BaTiO₃ nanoparticles. There is no need for subsequent annealing process for densification because the UV-curing process occurs nearly at room temperature. Effects of metal nanoparticle incorporation in bulk BaTiO₃–polymer composites have been well known as generating the beneficial increase of dielectric constant in the percolation-transition region while the dielectric loss depends on the type of composites and materials.^{15–17} Depending on the composite structure, the level of the increase of dielectric constant is determined. The embedded metal particles are known to produce extra interfacial polarization at the interfaces with the insulating matrix before the complete percolation occurs towards the metallic-like region.^{18,19}

The primary purpose of this work suggests a flexible nanocomposite system processable at near room temperature for a polymer substrate. The effects of several parameters, such as volume fraction and particle size of the BaTiO₃ filler and the content of Ag nanoparticles, on dielectric and current–voltage behaviors are investigated in this hybrid thick film system suitable for flexible capacitors. The incorporation of Ag into the BaTiO₃-based dielectric nanocomposites has been reported in various forms of materials, such as bulk, nanofibers and thin

Department of Materials Science and Engineering, Yonsei University, Seoul 03722, Korea. E-mail: ycho@yonsei.ac.kr

† Electronic supplementary information (ESI) available. See DOI: 10.1039/c7ra11640c

‡ Equally contributed.



films, requiring moderate or high temperature processing at $>160\text{ }^{\circ}\text{C}$ for densification.^{20–23} For example, the nanoscale Ag/BaTiO₃ dispersed-PVDF bulk composites exhibited $\epsilon_r \sim 160$ at 1 kHz when processed by hot pressing at $180\text{ }^{\circ}\text{C}$.²⁰ A composite film of Ag-coated BaTiO₃ nanofiber-polymer was also reported to have $\epsilon_r \sim 100$ at 1 kHz.²¹ This work may be the very first report dealing with room temperature processing without using complex inorganic or organic precursors. As a promising result here, a dielectric constant of ~ 303 with a low dielectric loss less than 0.1 was achieved for the $\sim 30\text{ }\mu\text{m}$ thick-nanocomposite films consisting of $\sim 81\text{ nm}$ BaTiO₃ and $\sim 34\text{ nm}$ Ag nanoparticles dispersed in a UV-cured polymer matrix.

2. Experimental section

Three different commercial BaTiO₃ powders having an average particle size of $3\text{ }\mu\text{m}$ (99% purity, Aldrich), $2\text{ }\mu\text{m}$ (99.5% purity, Aldrich) and 81 nm (99% purity, Aldrich) were thoroughly mixed with a commercially-available UV-curable organic vehicle (#3321, Loctite Co., USA) using a paste mixer (PDM-150, Daewha Tech, Korea) at 1200 rpm for 5 min to produce composite-type dielectric pastes. The components of UV polymer are *N,N*-dimethyl acrylamide, isobornyl acrylate, urethane acrylate oligomer, photoinitiator and organosilane ester. The content of BaTiO₃ powder relative to the organic vehicle changed from 17.6 to 56.2 vol%. To incorporate Ag, commercial Ag nanoparticles ($\sim 34\text{ nm}$ in average) were added by replacing the BaTiO₃ filler from 5 vol% to 30 vol% only for the 56.2 vol% BaTiO₃ sample. Accordingly, the 5 vol% Ag sample means a filler composition of 95 vol% BaTiO₃ and 5 vol% Ag while the total volume fraction of fillers is fixed at 56.2 vol%. The maximum 30 vol% Ag was very close to the limited one in a practical sense for forming a viscous paste for printing. The dielectric pastes were then screen-printed on an ITO-coated polyethylene terephthalate (PET) substrate (Fine Chemicals Industry, Korea). For the UV-curing process, the printed paste was cured by direct exposure to a UV light having an intensity of 500 W for 10 min in a UV furnace (JHCI-051B, Jueun UV Tech, Korea). The thickness of UV-cured samples was about $30\text{ }\mu\text{m}$, which can be controlled with the mesh size of screen and the viscosity of paste.

Fig. 1(a) and (b) demonstrates the simple fabrication steps of the UV-curable processing with the schematic illustration of a flexible capacitor device structure composed of Ag/BaTiO₃ nanoparticles in a UV-cured polymer matrix. The transmission electron microscopy (TEM, model G2 F20, Tecnai, FEI, USA) images of raw nanoparticle materials are seen in Fig. 1(c). The average sizes of the nanoscale BaTiO₃ and Ag particles were determined as $\sim 81\text{ nm}$ and $\sim 34\text{ nm}$, respectively. Microstructure of the composite thick films was observed by scanning electron microscopy (SEM, model S-4200, Hitachi, Nissei Sangyo, Japan). A patterned Pt top electrode was deposited by DC sputtering to make a sandwich structure for the dielectric measurement. Dielectric constant and loss tangent were measured at room temperature in the frequency range of 10^2 – 10^7 Hz by using an impedance analyzer (HP4194A, Hewlett-Packard, California, USA). Current–voltage characteristics were

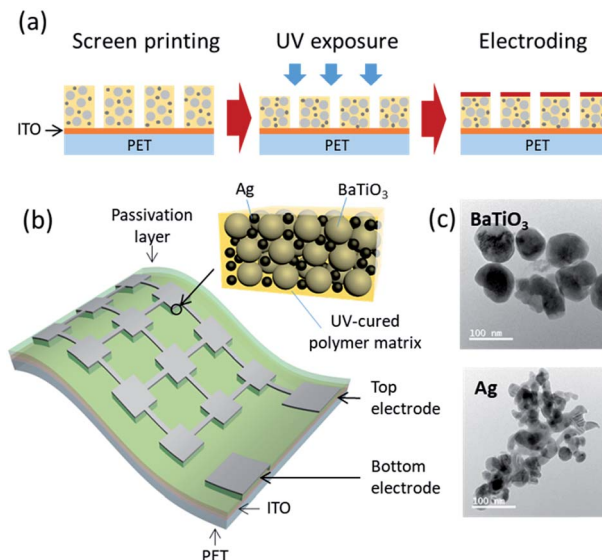


Fig. 1 (a) Schematic of the fabrication procedure of the flexible UV-cured nanocomposite thick films on a PET substrate and (b) the illustration of a flexible capacitor structure with (c) actual TEM images of nano-scale BaTiO₃ and Ag powders as dispersed fillers in UV-cured polymer matrix of the nanocomposite thick film.

measured by using a semiconductor parameter analyzer (HP4145B, Hewlett-Packard, California, USA).

3. Results and discussion

3.1. Effects of the size and content of BaTiO₃ particles

Fig. 2 shows the surface and cross-sectional SEM images selected to demonstrate the effects of different content and particle size of the BaTiO₃ filler on microstructure evolution with the curing process. The surface images of Fig. 2(a)–(c) show dispersed BaTiO₃ particles in the polymer matrix without significant voids or pores. Relatively uniform distribution of the filler particles can be seen from the surface microstructures. It seems that the curing time of 10 min is good enough for effective curing which is associated with the progress of photo-

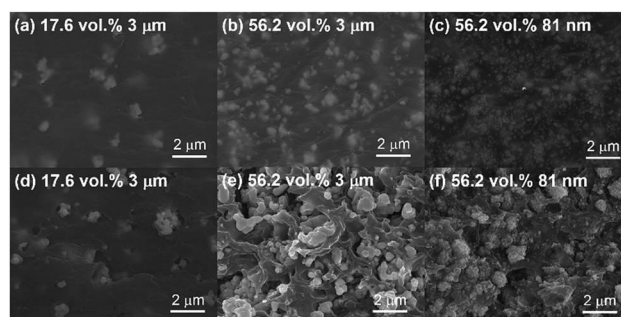


Fig. 2 Surface microstructures of UV-cured composite films containing (a) 17.6 vol% $3\text{ }\mu\text{m}$, (b) 56.2 vol% $3\text{ }\mu\text{m}$ and (c) 56.2 vol% 81 nm BaTiO₃ filler particles, and cross-sectional microstructures of UV-cured composites containing (d) 17.6 vol% $3\text{ }\mu\text{m}$, (e) 56.2 vol% $3\text{ }\mu\text{m}$ and (f) 56.2 vol% 81 nm BaTiO₃ filler particles.



oxidation of urethane bridges into a quinone-imide structure.^{24,25} Our commercial UV polymer is based on acrylated urethane with a high sensitivity to curing time. Compared to the film of 17.6 vol% BaTiO₃ (Fig. 2(a)), the composite with 56.2 vol% BaTiO₃ demonstrates more filler particles distributed uniformly (Fig. 2(b)). The UV polymer wets the surface of particles effectively and then forms a matrix network upon the short curing process.^{9,10} Clearly, the nanoscale particle size of 81 nm at the identical 56.2 vol% seemed to bring somewhat different microstructural features as shown in Fig. 2(c). More finely dispersed BaTiO₃ nanoparticles are easily seen in the surface image. Cross-sectional microstructures of Fig. 2(d)–(f) exhibit the similar trends with the features observed in the surface ones except that the interior of the films tends to show less densified states than the surfaces. Probably the curing process more dominantly happens over the surface since a short duration of curing is used. As a clear example, Fig. 2(e) shows a considerable portion of porosity as a result of insufficient wetting of the polymer onto the filler particles. We evaluated quantitatively the level of porosity using an image analysis from the cross-sectional microstructures of Fig. 2(d–f) as shown in Fig. S1 of the ESI.† The image analysis may not represent the true number of porosity. According to the estimation, the 56.2 vol% 3 μ m sample (Fig. 2(e)) showed the largest porosity of \sim 12.8% while the 56.2 vol% 81 nm sample had a porosity of \sim 3.7%.

Fig. 3 shows the dependence of BaTiO₃ content on dielectric constant and loss of the thick films with different particle sizes of 81 nm, 2 μ m and 3 μ m, which were measured at 1 kHz. The dielectric constant of all composite films increased with the content of BaTiO₃. The increasing tendency of dielectric constant with increasing the relative content of BaTiO₃ was more prominent in the case of 81 nm particle size. Dielectric constant reached to \sim 36.4 at 56.2 vol% BaTiO₃ when the smallest particle size of 81 nm was used. There have been similar reports where the smaller particle size creates more homogeneous matrix and the larger dielectric constant in ceramic-polymer composites by creating a larger surface area for effective polarization.^{26–28} The improvement of dielectric constant is also associated with better density and dispersion of the particles in the polymer matrix.

Dielectric loss was also found to depend on particle size and volume fraction of the filler as shown in Fig. 3(b). The loss values were quite stable over the filler volume change, with the increasing tendency of the loss with the increase of filler. The increasing tendency must be associated with the creation of more effective interfaces between the filler and polymer matrix, where the interface-driven dielectric loss is produced dominantly.^{11,29,30} The smaller particle size tends to produce the lower values of dielectric loss. Generally a loss value of less than 0.1 is preferred in the capacitive applications. It is assumed that the well-dispersed fillers with less porosity in the 81 nm case contribute to the reduction of dielectric loss from the highly leaky polymer.

Fig. 4(a) shows the frequency dependence of dielectric constant for the samples having different particle sizes but containing the same content of 56.2 vol% BaTiO₃. The smaller particle size exhibited the stronger dependence of dielectric constant on frequency, with higher dielectric constants at the same frequency. As expected from the frequency dependence of dielectric constant in intrinsic BaTiO₃,³¹ all the three samples showed similar decreasing tendency of dielectric constant over the frequency range from 10² to 10⁷ Hz. Less sensitive dependence of frequency with the larger particle size is anticipated due to less contribution of BaTiO₃ to polarization degradation with higher frequency as reported in the study of other BaTiO₃-polymer composites.^{10,26} Fig. 4(b) shows another frequency dependence of dielectric constant, which were obtained for the samples containing the same particle size of 81 nm but having different volume fraction of BaTiO₃ filler in the identical frequency range. Dielectric constant was found to decrease gradually with increasing the frequency, which depends on the volume fraction. The larger volume of filler tended to induce a larger drop of dielectric constant with increasing frequency. Thick films with a larger volume of BaTiO₃ follow more closely the relaxation behavior of BaTiO₃ itself. The polymer is likely to have very weak dependency of frequency from the least polarization in this frequency range.

The mechanical integrity of the flexible samples was evaluated by applying the bending stress and then measuring dielectric properties under the bending strain as shown in Fig. S2.† As anticipated, the variations of dielectric constant and loss are well maintained up to the strain level of \sim 1.7%. It

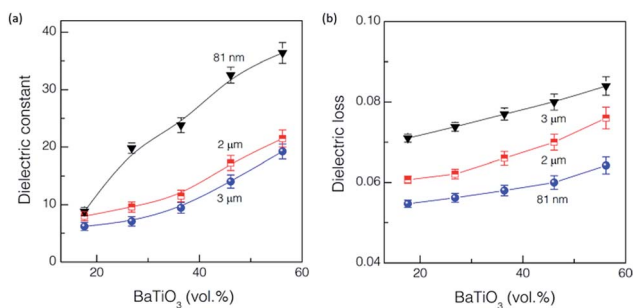


Fig. 3 Variations of (a) dielectric constant and (b) dielectric loss as a function of BaTiO₃ content for the samples with different average particle size of BaTiO₃ filler.

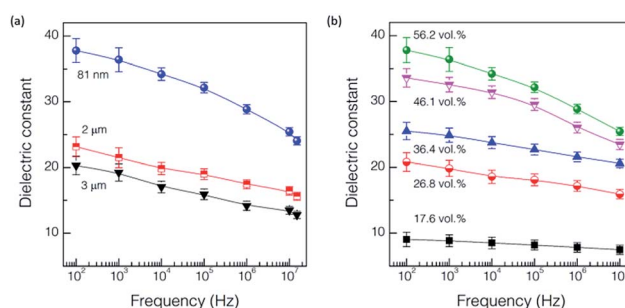


Fig. 4 Frequency dependence of dielectric constant in the BaTiO₃-composite thick films with (a) different particle sizes of the 56.2 vol% BaTiO₃ filler and (b) different contents of the 81 nm BaTiO₃ filler.



suggests that the UV-cured composite films are very competitive in the flexible environment, without creating significant fracture. Typically, the inorganic thin films of a few hundreds of nm in thickness can withstand the bending strain of only $\sim 1.0\%$ without causing the mechanical damage.^{32,33}

In addition, the estimated dielectric behaviors of the samples according to several dielectric prediction models can be referred to Fig. S3.† It suggests that the effective medium theory (EMT) model is well suited for the estimation of effective dielectric constant variations of the nanocomposites with the particle size of BaTiO₃ filler.

3.2. Effects of dispersed Ag nanoparticles in nanocomposite films

The addition of Ag nanoparticles for the 56.2 vol% 81 nm BaTiO₃ nanocomposite thick films was investigated in regard with the effects of dielectric and current-voltage behavior. The dispersion of Ag nanoparticles was found to be recognizable as represented in the surface SEM image of the maximum 30 vol% Ag case with the elemental mapping in Fig. S4.† Fig. 5 shows the frequency dependence of dielectric constant and loss in the BaTiO₃ thick films partially substituted with the Ag nanoparticles, which were measured at 1 kHz. As expected, the dielectric constant tends to increase gradually with increasing the volume fraction of Ag nanoparticle by reaching ~ 303 with the 30 vol% Ag, suggesting the percolation transition with a higher content of Ag.^{15,18} The increase is very substantial compared to the value of ~ 36.4 for the sample without Ag. It seems that the Ag nanoparticles are surrounded by the polymer matrix and thus their conductive paths are confined in the composite structure up to the maximum of 30 vol% Ag.^{18,19} It is very noticeable that the dielectric loss values were maintained at the level of <0.1 regardless of Ag content (Fig. 5(b)).

Fig. 6 shows the frequency dependence of dielectric constant and loss values for the UV-cured nanocomposite thick films incorporating different contents of Ag nanoparticles. The dielectric constant of the thick films tends to be reduced as the frequency increases regardless of the level of Ag incorporation. The thick films having high contents of Ag, such as 20 and 30 vol%, exhibited the distinct behavior of dielectric relaxation

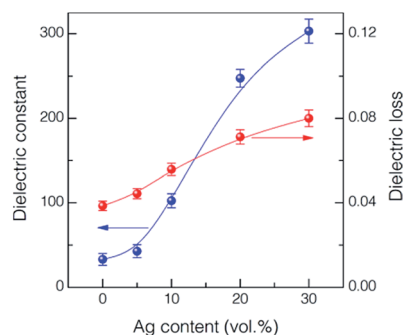


Fig. 5 Variations of dielectric constant and loss at 1 kHz as a function of Ag content for the UV-cured 56.2 vol% 81 nm BaTiO₃ nanocomposite thick films.

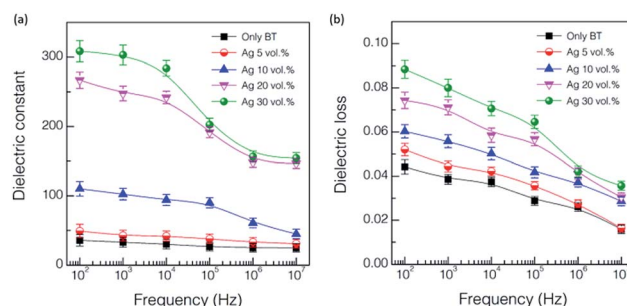


Fig. 6 Frequency dependence of (a) dielectric constant and (b) dielectric loss for the UV-cured 56.2 vol% 81 nm BaTiO₃ nanocomposite thick films having different volume fractions of Ag particles; the volume fraction of Ag indicates the substituted fraction for the BaTiO₃ filler.

in the frequency range of 10^4 to 10^6 , which follow the typical relaxation behavior of BaTiO₃.¹⁶ The frequency dependence of dielectric loss in Fig. 6(b) is also the anticipated one as it shows the decreasing tendency with increasing frequency depending on the content of Ag in the thick films. The dependency of frequency becomes larger with the increase of Ag content.

Fig. 7 shows the plots of current density with applied electric field for the samples having different contents of Ag nanoparticles. The current density with electric field was dependent on the content of Ag. The current density is minimal up to the content of 10 vol% Ag as seen in the inserted highlighted plots of Fig. 7(a), while the increased content of Ag above 20 vol% demonstrates the considerable current density even with a small electric field. The estimated leakage current density increased gradually from 4.6×10^{-7} A cm⁻² for no Ag sample to ~ 2.11 A cm⁻² for the 30 vol% Ag sample (Fig. 7(b)). The observed dependence of the leakage current on the content of Ag nanoparticles is reasonable when considered that the incorporated Ag acts as an electrical channel with the increase of electric field.^{18,19} It is likely that a higher packing density of the composite thick films is critical in reducing the leakage current density.

We compared the current performance with reported composite cases consisting of BaTiO₃ and metal nanoparticles in various forms of bulk and thin film as shown in Fig. 8.

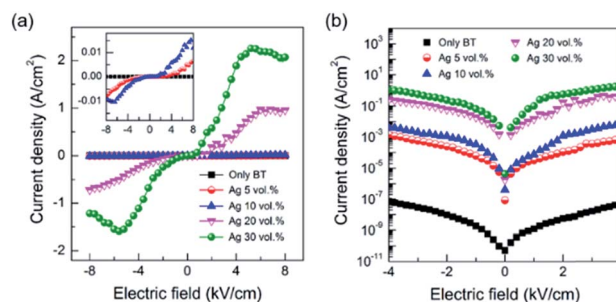


Fig. 7 Plots of current density versus electric field for the UV-cured 81 nm BaTiO₃ nanocomposite thick films containing different contents of Ag nanoparticles. The (b) plot corresponds to the log scale of the current density.



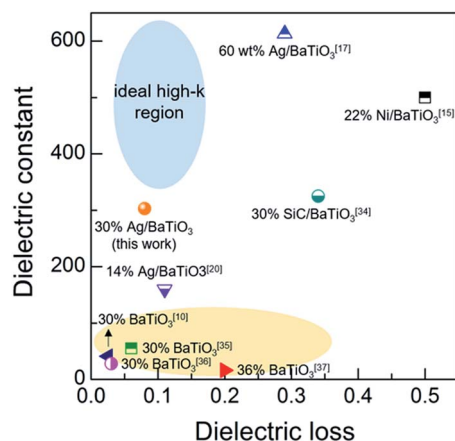


Fig. 8 Comparisons of the dielectric constant and loss of the current work with the reported values of the representative BaTiO₃-based high ϵ_r polymer composites having various forms and thickness: 100 μm -thick thin wafer in ref. 10, 1 mm-thick pellets in ref. 15, 17 and 20, 500 μm -thick pellet in ref. 34, 25 μm -thick cast film in ref. 35, 55–75 μm -thick cast film in ref. 36, and spin-coated film (no thickness information) in ref. 37.

Ideally, a higher dielectric constant and a lower dielectric loss are preferred as highlighted with the shaded circle. Our results are close enough to the ideal region by demonstrating the dielectric constant of ~ 303 with a loss of ~ 0.08 . The composite cases with higher ϵ_r than our value are based on thermally cured bulk samples heat-treated at 160 to 200 $^{\circ}\text{C}$.^{15,17,34} The yellow highlighted region in the left bottom region of Fig. 8 corresponds to the BaTiO₃-based composite examples not containing percolative metal particles,^{10,35–37} which can be characterized with low dielectric constant with acceptable dielectric loss. The current result may be meaningful in that a dielectric constant of >300 with a dielectric loss of <0.1 is achievable by a very simple experimental procedure of screen-printing and room-temperature curing on a flexible polymer substrate.

4. Conclusions

A nonconventional way was introduced to produce flexible high ϵ_r nanocomposite thick films at near room temperature by using the UV-curing process for formation of a polymer-based matrix. The dense composite film structure of $\sim 30\ \mu\text{m}$ in thickness was obtained by screen-printing on a PET substrate and then by the UV-curing process at near room temperature only for 10 min. Different particle sizes of BaTiO₃ from 81 nm to 3 μm were evaluated to pursue the optimal dielectric constant, with the variations of the volume fraction of the filler up to 56 vol%. A smaller size of BaTiO₃ filler was beneficial in producing better dielectric performance. The combination of $\sim 81\ \text{nm}$ BaTiO₃ and $\sim 34\ \text{nm}$ Ag nanoparticles for the printable composite thick films resulted in a dielectric constant of ~ 300 and a dielectric loss of 0.08. Current-voltage curves of the nanocomposite films suggested the dependence of Ag content on electrical leakage current behaviour.

Conflicts of interest

There are no conflicts to declare.

Acknowledgements

This work was financially supported by a grant (NRF-2016M3A7B4910151) of the National Research Foundation of Korea and also by the Industrial Strategic Technology Development Program (#10079981) funded by the Ministry of Trade, Industry & Energy (MOTIE) of Korea. We also acknowledge Dr Koppole C. Sekhar for his initial contribution to this work.

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